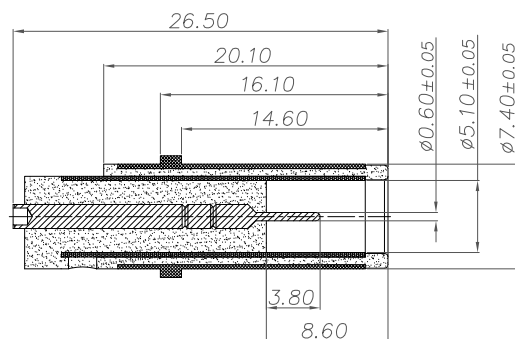
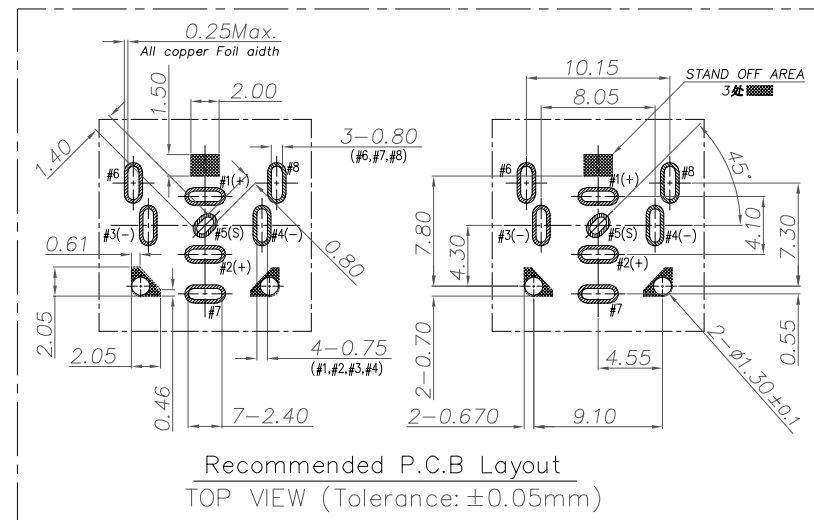
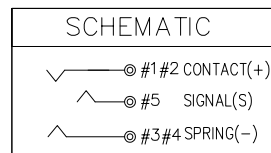
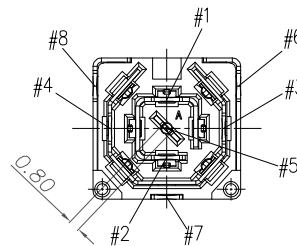
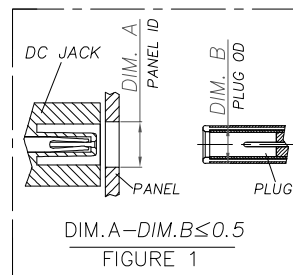




MATING PLUG: OD ϕ 7.4; ID ϕ 0.6
TOLERANCE: $\pm$ 0.05

4. FOR REFLOW SOLDERING LEAD-FREE PROCESS.

E	SHELL	1	USU301 1/2H t=0.30	Ni 60u"MIN
D	SIGNAL(S)	1	C5210-EH t=0.30	GOLD FLASH ON CONTACT AREA; MATTE Sn 120u" ON SOLDER TALL; ALL OVER Ni 50u".
C	SPRING(+)	1	C5210-EH t=0.25	
B	SPRING(-)	1	C5210-EH t=0.25	
A	BODY	1	PA10T UL94V-0	BLACK
NO.	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR

XGB 东莞市溪榜电子有限公司
DONG GUAN XI BANG ELECTRONICS CO., LTD.

DECIMALS:		ANGLES:		DESIGN:	Tony	PART NAME:	
DIM	TOL	DIM	TOL		2021.9.16	DC POWER JACK	
X.	±0.50	X.	±2°	CHECK:		PART NO.	
X.X	±0.30	X.X	±1°			XB-DC-740060-1283-20000H	
X.XX	±0.20	X.XX	—			SHEET: 1/1 REV.: A1	
X.XXX	±0.10	X.XXX	—	APPROVED	Andy	DRAWING NO	
 3RD ANGLE PROJECTION		UNIT: mm			2021.9.16		

REV.	ECN NO.	DESCRIPTION	DESIGN	DATE
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